$CONDUCTIVE\ STRUCTURE\ FABRICATION\ PROCESS\ USING\ NOVEL\ LAYERED\ STRUCTURE...$

Basol et al.

Appl. No.: 10/663,318 Atty Docket: ASMNUT.124C1

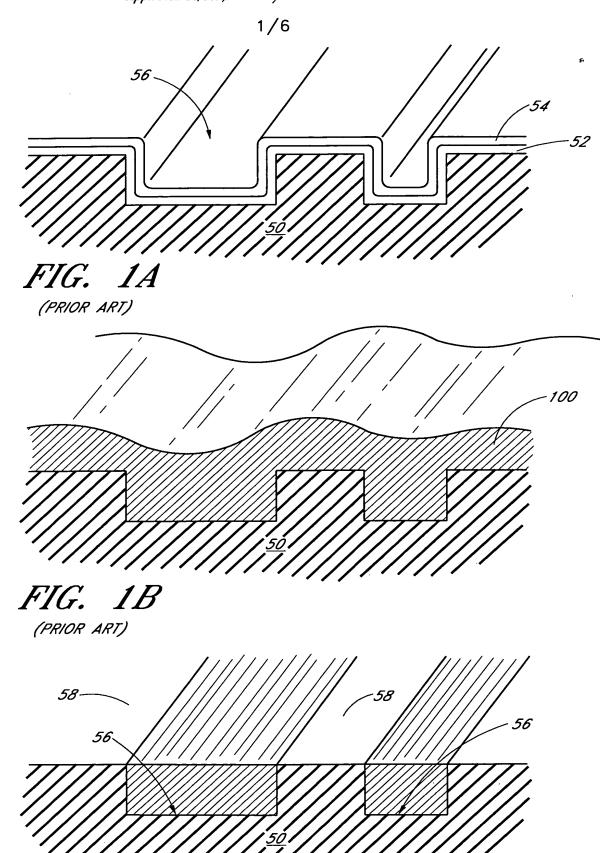
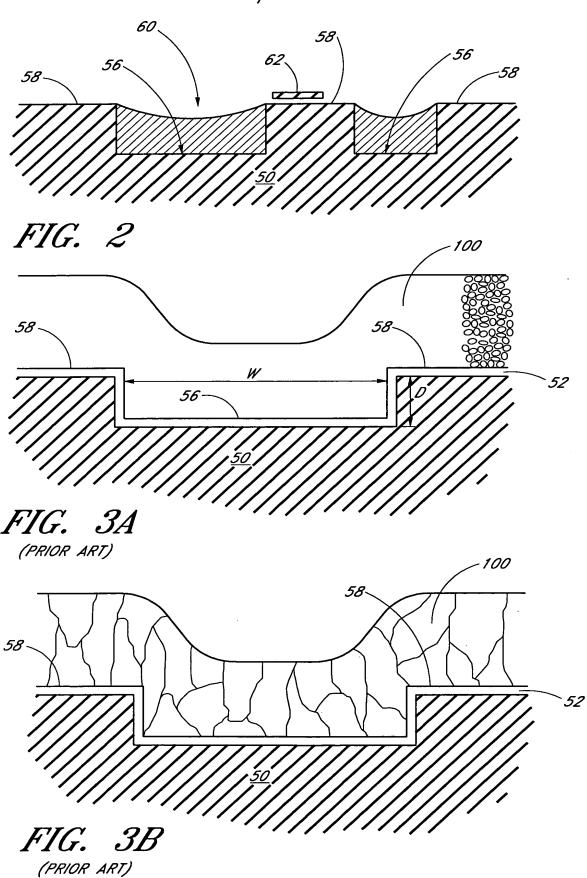


FIG. 1C

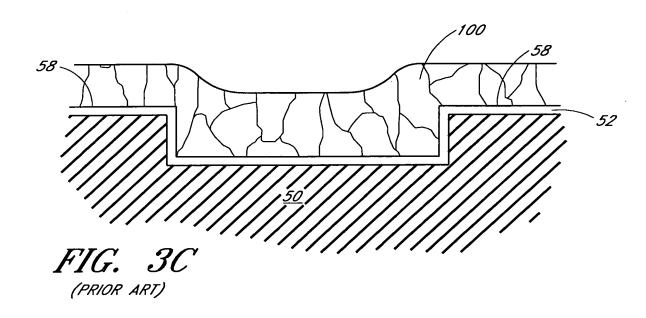
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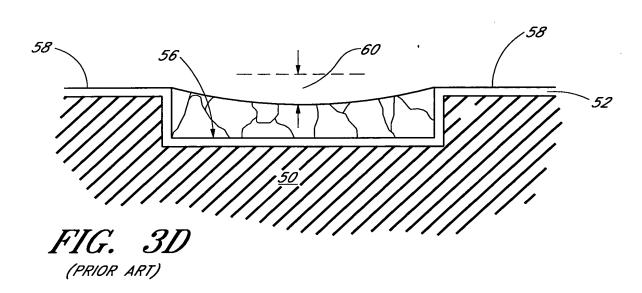
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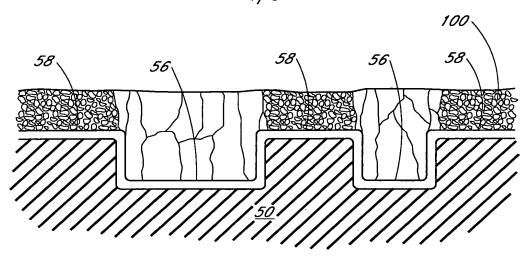
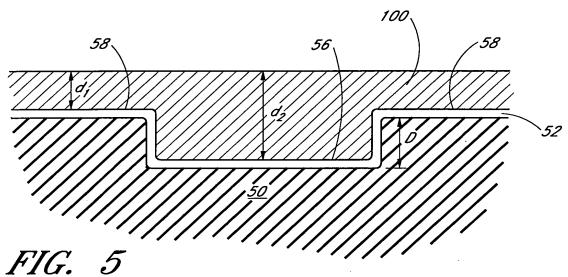


FIG. 4



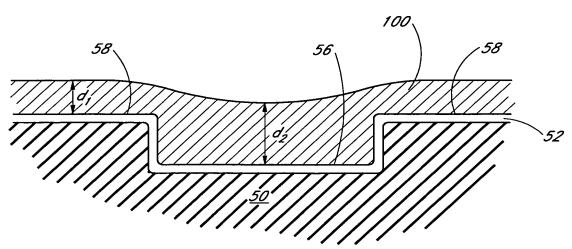
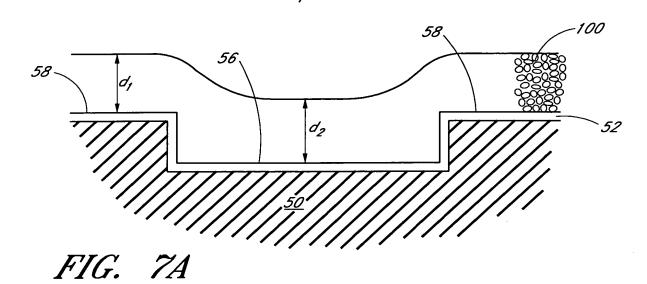
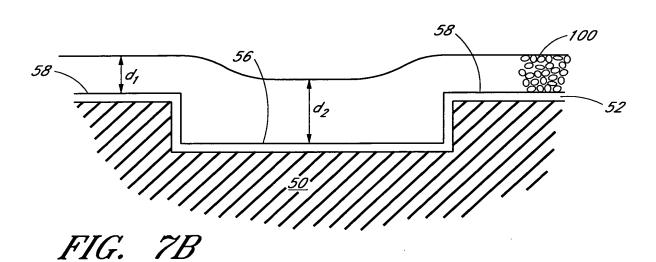


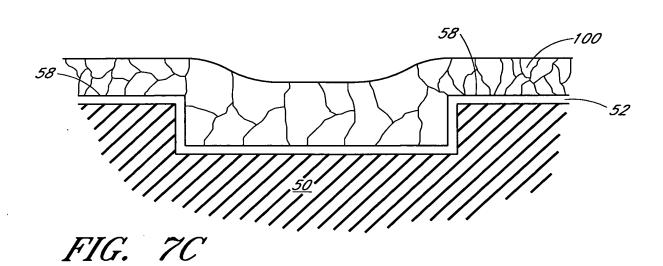
FIG. 6

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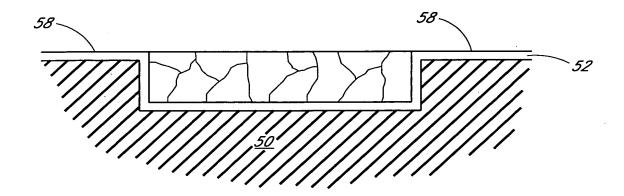


FIG. 8

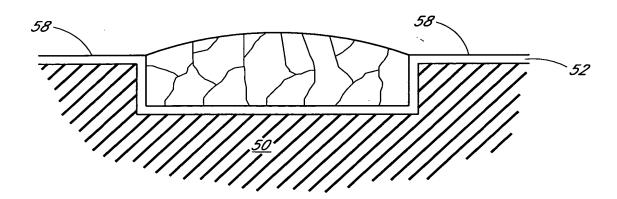


FIG. 9